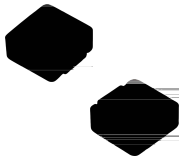


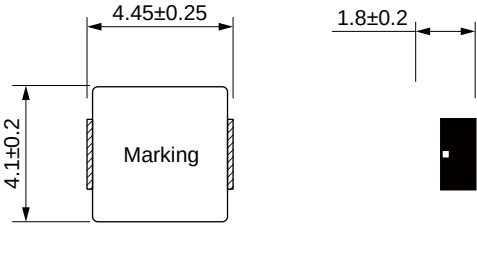
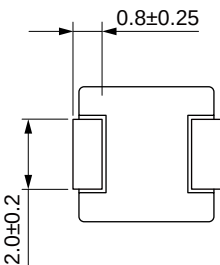
SMD Low Profile High Current Molded Inductor
Size 4020



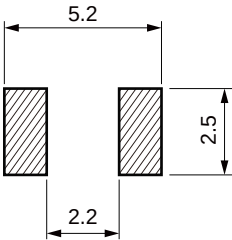
- {KλŠtŘŠŘ ŐzyăúNdzŐăzy
- Capable of corresponding high frequency .
- Low loss realized with low DCR.
- High performance (Isat) realized by metal dust core.
- ! túNŮ t2ø òdzÎÎ y2λăŠΣ ŘdzŠ ú2 Ő2YŁJ2ăλúŠ Ő2yăúNdzŐăzy
- 100% Lead(Pb)-Free and RoHS compliant.
- ! 9/πνнлł Ijdzł-łŬŠŘ
- hŁJŠNŮł-ăyă ũŠYŁJŠNŮł-űdzNŮŠY πpp ũ2 ěmpp c / ólyŐfdzŘłyă äŠfFπúŠYŁJŠNŮł-űdzNŮŠ NŮăŠú
- vdzł-yăűëY оллт / {

- I Šł-Řłł-YŁJă ũł-łł łł-YŁJă ł-yŘ łyűŠNŮ2NŮ łłKăyă
- HVAC
- 522Năš ølyŘ2ø łłD ł-yŘ äŠ Š " ŬŠ h ũ
-
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Dimensions: [mm]

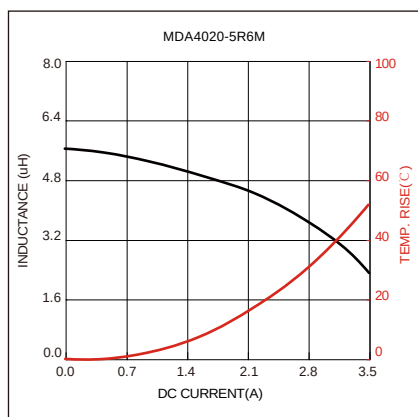
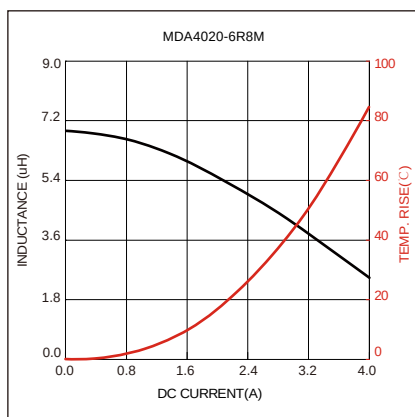
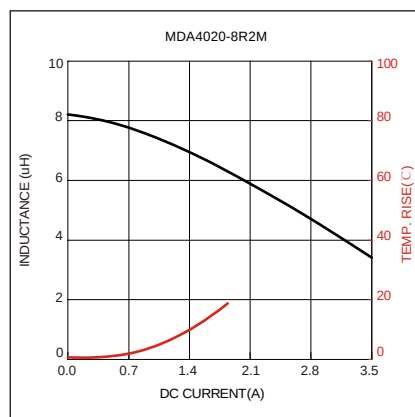


Land Pattern: [mm]



Electrical Properties:

Part No	Tolerance	Current Typ. (A)	DC Resistance Typ.	Current Max. (A)
MDA4020-R10M	±20%	26.0	2.90	o
	±20%	мрл	4.80	ср Ă
	±20%	9.0	флрл	8.0
	±20%	7.6	11.6	6.6
	±20%	рлр	19.0	рл
	±20%	рлн	27.0	4.8
	±20%	плр	41.0	4.0
	±20%	офм	срл	2.7
	±20%	2.8	84.0	нлр



Soldering Reflow:

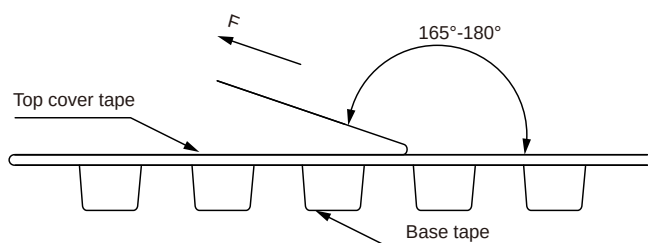
Preheat condition: 150 ~200℃ / 60~120 sec.

Allowed time above 217℃ : 60~90 sec.

Packaging Information:

Tape Dimension:

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

